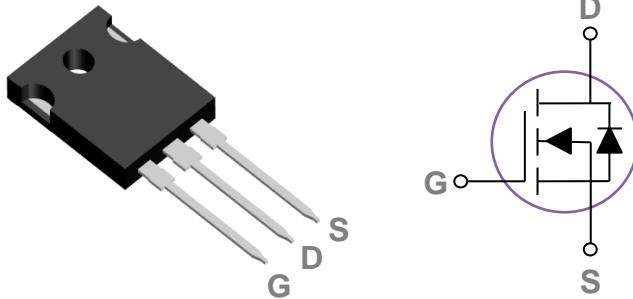


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO247 Pin Configuration



| BVDSS | RDS(ON) | ID   |
|-------|---------|------|
| 80V   | 1.5mΩ   | 330A |

### Features

- 80V,330A,  $RDS(ON) = 1.5m\Omega @ VGS = 10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

### Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

| Symbol    | Parameter                                        | Rating     | Units         |
|-----------|--------------------------------------------------|------------|---------------|
| $V_{DS}$  | Drain-Source Voltage                             | 80         | V             |
| $V_{GS}$  | Gate-Source Voltage                              | $\pm 20$   | V             |
| $I_D$     | Drain Current – Continuous ( $T_c=25^\circ C$ )  | 330        | A             |
|           | Drain Current – Continuous ( $T_c=100^\circ C$ ) | 211        | A             |
| $I_{DM}$  | Drain Current – Pulsed <sup>1</sup>              | 1320       | A             |
| EAS       | Single Pulse Avalanche Energy <sup>2</sup>       | 3698       | mJ            |
| IAS       | Single Pulse Avalanche Current <sup>2</sup>      | 86         | A             |
| $P_D$     | Power Dissipation ( $T_c=25^\circ C$ )           | 595        | W             |
|           | Power Dissipation – Derate above $25^\circ C$    | 4.8        | W/ $^\circ C$ |
| $T_{STG}$ | Storage Temperature Range                        | -55 to 150 | $^\circ C$    |
| $T_J$     | Operating Junction Temperature Range             | -55 to 150 | $^\circ C$    |

### Thermal Characteristics

| Symbol          | Parameter                              | Typ. | Max. | Unit         |
|-----------------|----------------------------------------|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | ---  | 62   | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case    | ---  | 0.21 | $^\circ C/W$ |

**Electrical Characteristics ( $T_J=25\text{ }^{\circ}\text{C}$ , unless otherwise noted)**
**Off Characteristics**

| Symbol     | Parameter                      | Conditions                                                                  | Min. | Typ. | Max.      | Unit          |
|------------|--------------------------------|-----------------------------------------------------------------------------|------|------|-----------|---------------|
| $BV_{DSS}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$                                   | 80   | ---  | ---       | V             |
| $I_{DSS}$  | Drain-Source Leakage Current   | $V_{DS}=64\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25\text{ }^{\circ}\text{C}$ | ---  | ---  | 1         | $\mu\text{A}$ |
|            |                                | $V_{DS}=64\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=85\text{ }^{\circ}\text{C}$ | ---  | ---  | 30        | $\mu\text{A}$ |
| $I_{GSS}$  | Gate-Source Leakage Current    | $V_{GS}=\pm 20\text{V}$ , $V_{DS}=0\text{V}$                                | ---  | ---  | $\pm 100$ | $\text{nA}$   |

**On Characteristics**

|                     |                                   |                                        |     |     |     |                  |
|---------------------|-----------------------------------|----------------------------------------|-----|-----|-----|------------------|
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance | $V_{GS}=10\text{V}$ , $I_D=30\text{A}$ | --- | 1.2 | 1.5 | $\text{m}\Omega$ |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage            | $V_{GS}=V_{DS}$ , $I_D=250\mu\text{A}$ | 2   | 2.8 | 4   | V                |
| $g_{fs}$            | Forward Transconductance          | $V_{DS}=10\text{V}$ , $I_D=3\text{A}$  | --- | 20  | --- | S                |

**Dynamic and switching Characteristics**

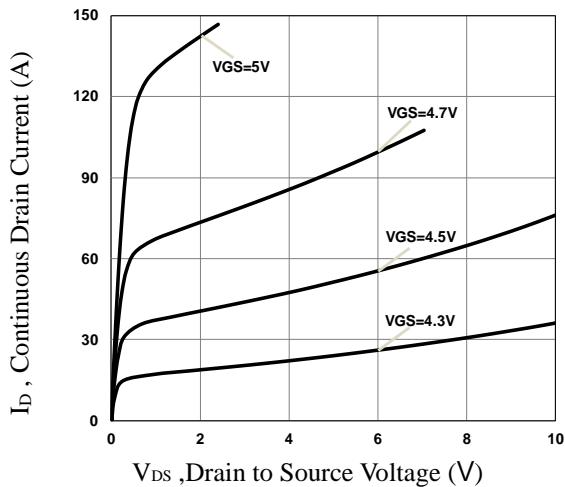
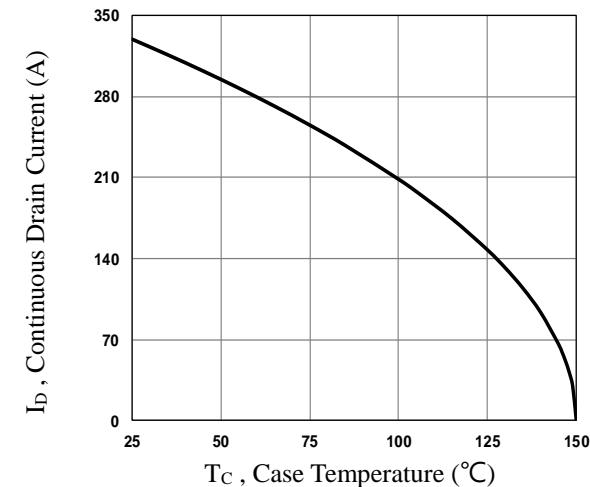
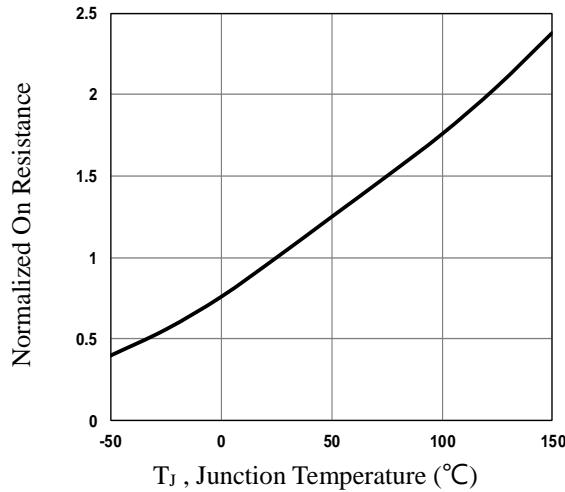
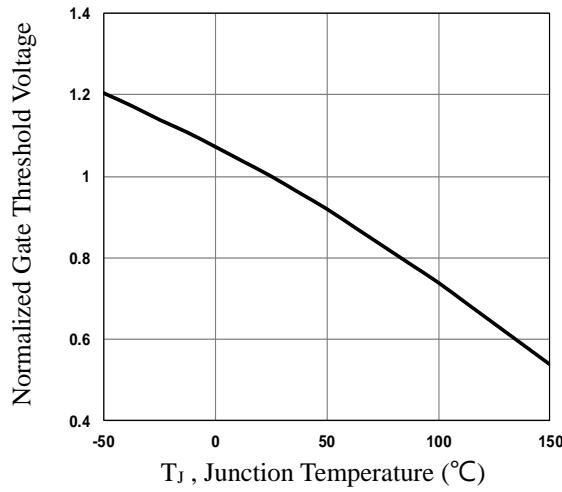
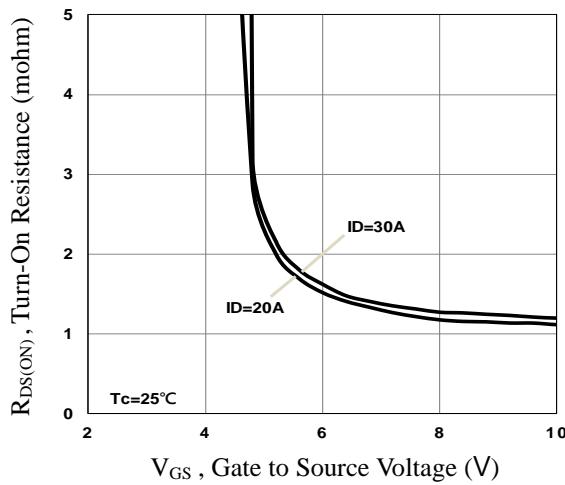
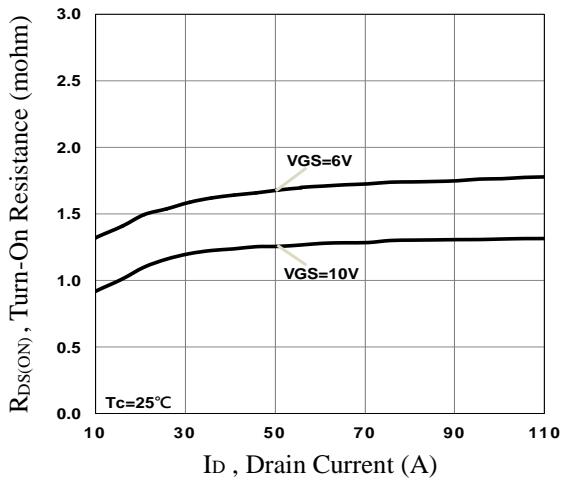
|              |                                     |                                                                                |     |       |       |          |
|--------------|-------------------------------------|--------------------------------------------------------------------------------|-----|-------|-------|----------|
| $Q_g$        | Total Gate Charge <sup>3, 4</sup>   | $V_{DS}=40\text{V}$ , $V_{GS}=10\text{V}$ , $I_D=100\text{A}$                  | --- | 206   | 310   | nC       |
| $Q_{gs}$     | Gate-Source Charge <sup>3, 4</sup>  |                                                                                | --- | 54    | 80    |          |
| $Q_{gd}$     | Gate-Drain Charge <sup>3, 4</sup>   |                                                                                | --- | 56    | 85    |          |
| $T_{d(on)}$  | Turn-On Delay Time <sup>3, 4</sup>  | $V_{DD}=40\text{V}$ , $V_{GS}=10\text{V}$ , $R_G=6\Omega$<br>$I_D=100\text{A}$ | --- | 30    | 45    | ns       |
| $T_r$        | Rise Time <sup>3, 4</sup>           |                                                                                | --- | 70    | 105   |          |
| $T_{d(off)}$ | Turn-Off Delay Time <sup>3, 4</sup> |                                                                                | --- | 40    | 60    |          |
| $T_f$        | Fall Time <sup>3, 4</sup>           |                                                                                | --- | 80    | 120   |          |
| $C_{iss}$    | Input Capacitance                   | $V_{DS}=40\text{V}$ , $V_{GS}=0\text{V}$ , $F=1\text{MHz}$                     | --- | 13000 | 19500 | pF       |
| $C_{oss}$    | Output Capacitance                  |                                                                                | --- | 3100  | 4650  |          |
| $C_{rss}$    | Reverse Transfer Capacitance        |                                                                                | --- | 54    | 80    |          |
| $R_g$        | Gate resistance                     | $V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $F=1\text{MHz}$                      | --- | 1.9   | ---   | $\Omega$ |

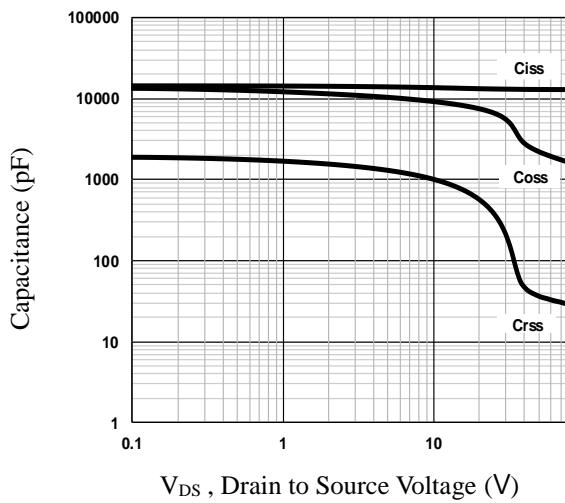
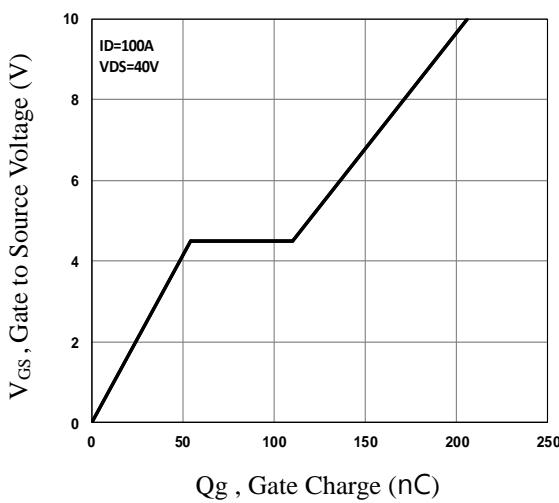
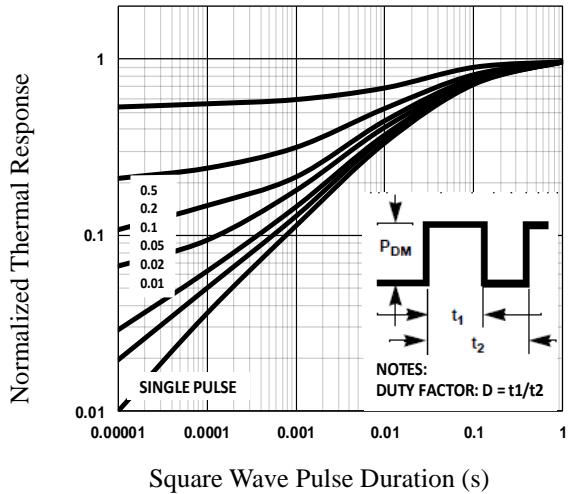
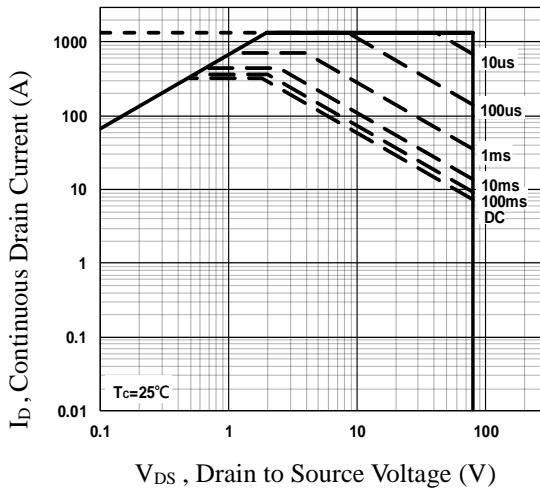
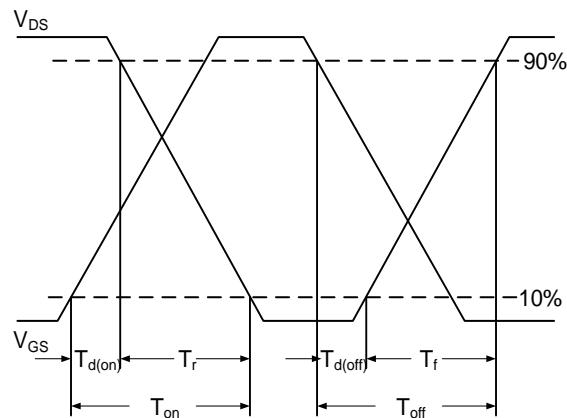
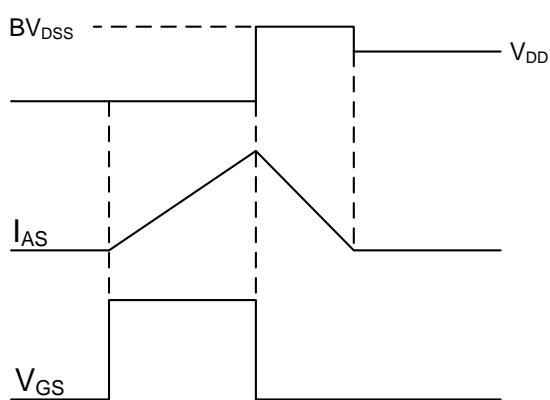
**Drain-Source Diode Characteristics and Maximum Ratings**

| Symbol   | Parameter                 | Conditions                                                                                                | Min. | Typ. | Max. | Unit |
|----------|---------------------------|-----------------------------------------------------------------------------------------------------------|------|------|------|------|
| $I_s$    | Continuous Source Current | $V_G=V_D=0\text{V}$ , Force Current                                                                       | ---  | ---  | 330  | A    |
| $I_{SM}$ | Pulsed Source Current     |                                                                                                           | ---  | ---  | 660  | A    |
| $V_{SD}$ | Diode Forward Voltage     | $V_{GS}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25\text{ }^{\circ}\text{C}$                                   | ---  | ---  | 1    | V    |
| $t_{rr}$ | Reverse Recovery Time     | $V_R=50\text{V}$ , $I_s=10\text{A}$<br>$di/dt=100\text{A}/\mu\text{s}$ , $T_J=25\text{ }^{\circ}\text{C}$ | ---  | 125  | ---  | ns   |
| $Q_{rr}$ | Reverse Recovery Charge   |                                                                                                           | ---  | 460  | ---  | nC   |

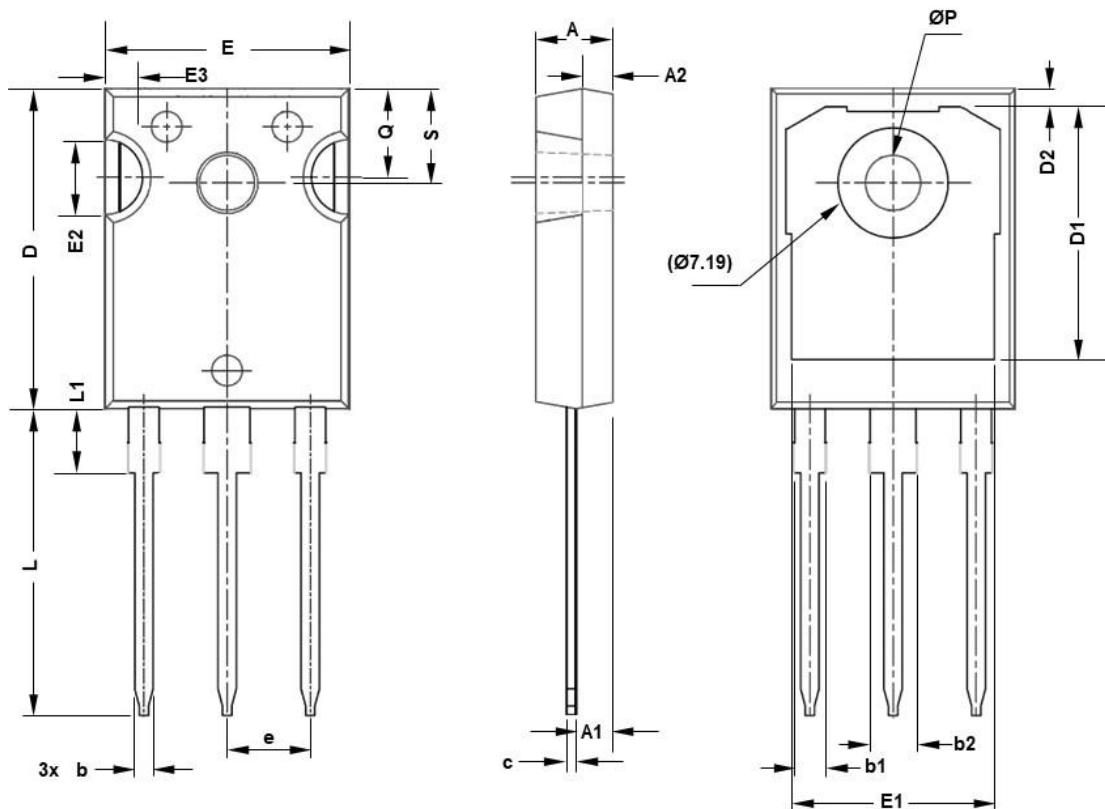
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=50\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=1\text{mH}$ ,  $I_{AS}=86\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25\text{ }^{\circ}\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Typical Output Characteristics**

**Fig.2 Continuous Drain Current vs.  $T_c$** 

**Fig.3 Normalized  $R_{DS(ON)}$  vs.  $T_j$** 

**Fig.4 Normalized  $V_{th}$  vs.  $T_j$** 

**Fig.5 Turn-On Resistance vs.  $V_{GS}$** 

**Fig.6 Turn-On Resistance vs.  $I_D$**


**Fig.7 Capacitance Characteristics**

**Fig.8 Gate Charge Characteristics**

**Fig.9 Normalized Transient Impedance**

**Fig.10 Maximum Safe Operation Area**

**Fig.11 Switching Time Waveform**

**Fig.12 EAS Waveform**

## TO247 PACKAGE INFORMATION



| SYMBOL | mm    |       | SYMBOL | mm      |       |
|--------|-------|-------|--------|---------|-------|
|        | MIN   | MAX   |        | MIN     | MAX   |
| A      | 4.83  | 5.21  | E2     | 4.32    | 5.49  |
| A1     | 2.29  | 2.55  | E3     | 2.15    | 2.80  |
| A2     | 1.50  | 2.49  | e      | 5.44BSC |       |
| b      | 1.12  | 1.33  | L      | 19.81   | 20.32 |
| b1     | 1.91  | 2.39  | L1     | 4.10    | 4.40  |
| b2     | 2.87  | 3.22  | φP     | 3.56    | 3.65  |
| C      | 0.55  | 0.69  | Q      | 5.39    | 6.20  |
| D      | 20.80 | 21.10 | S      | 6.04    | 6.30  |
| D1     | 16.25 | 17.65 |        |         |       |
| D2     | 0.51  | 1.35  |        |         |       |
| E      | 15.75 | 16.13 |        |         |       |
| E1     | 13.46 | 14.16 |        |         |       |